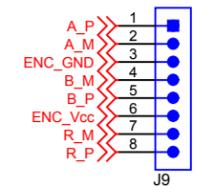
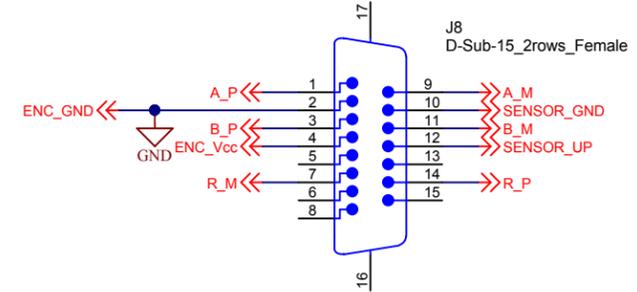
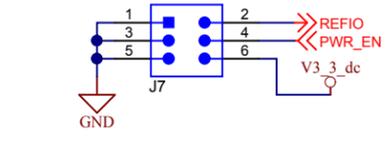
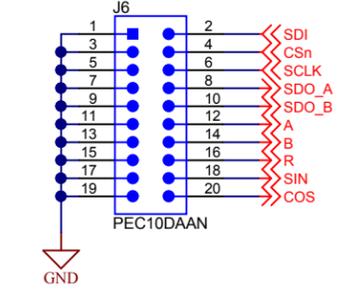
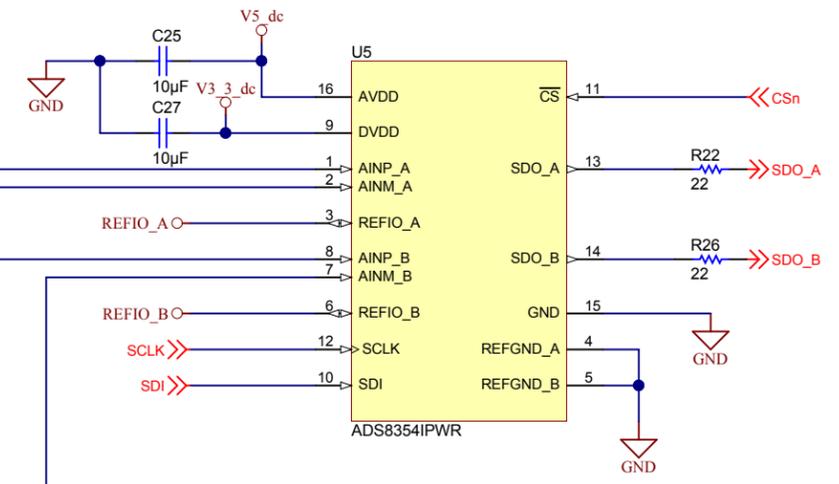


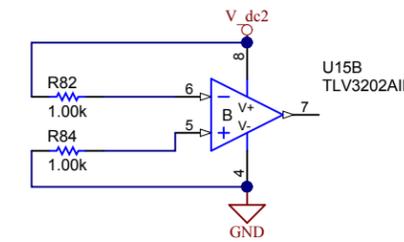
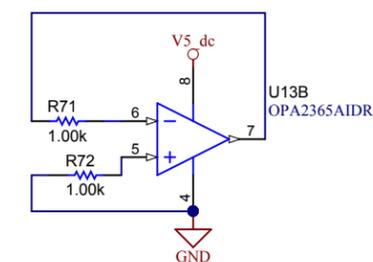
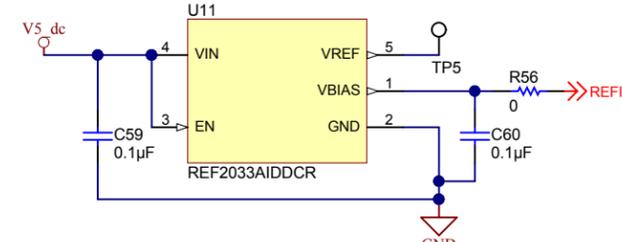
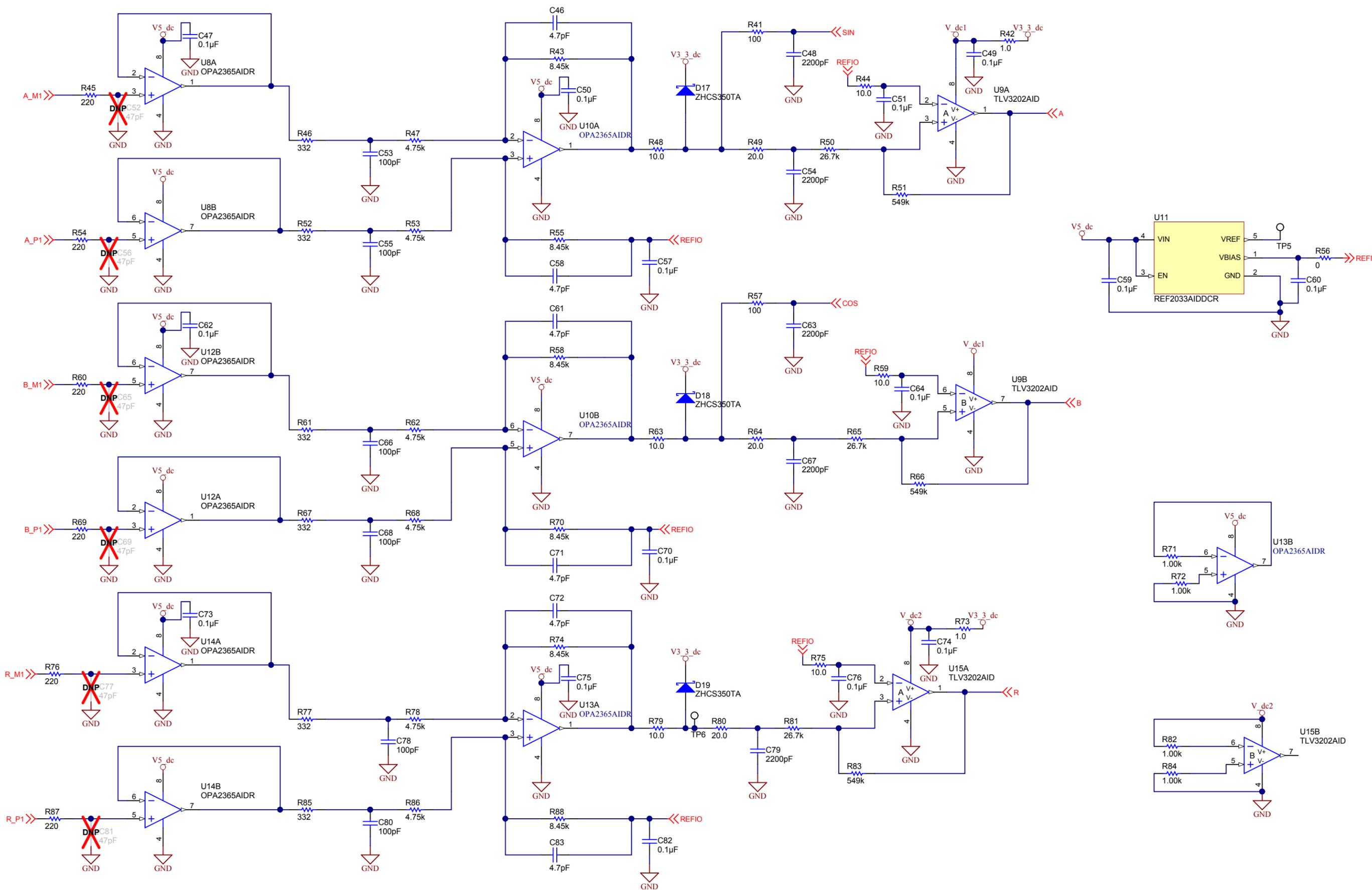
NOTE
 The differential inputs A+,A- are swapped and connected to ADS8354 AINM_B and AINP_B
 The differential inputs B+,B- are swapped and connected to ADS8354 AINM_A and AINP_A
 Since both signals are sampled simultaneously there's no impact.
 Adjust in software by invertring and swapping the results.
 This was done to optimize layout for best performance minimizing vias and signal crossings.



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Number: TIDA-00176	Rev: E1	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: TIDA-00176_REVE1_products	Sheet: 2 of 3
Drawn By:	File: TIDA-00176_SCLS.SchDoc	Size: B
Engineer: Stauder/Pizzolante/Staebli	Contact: http://www.ti.com/support	

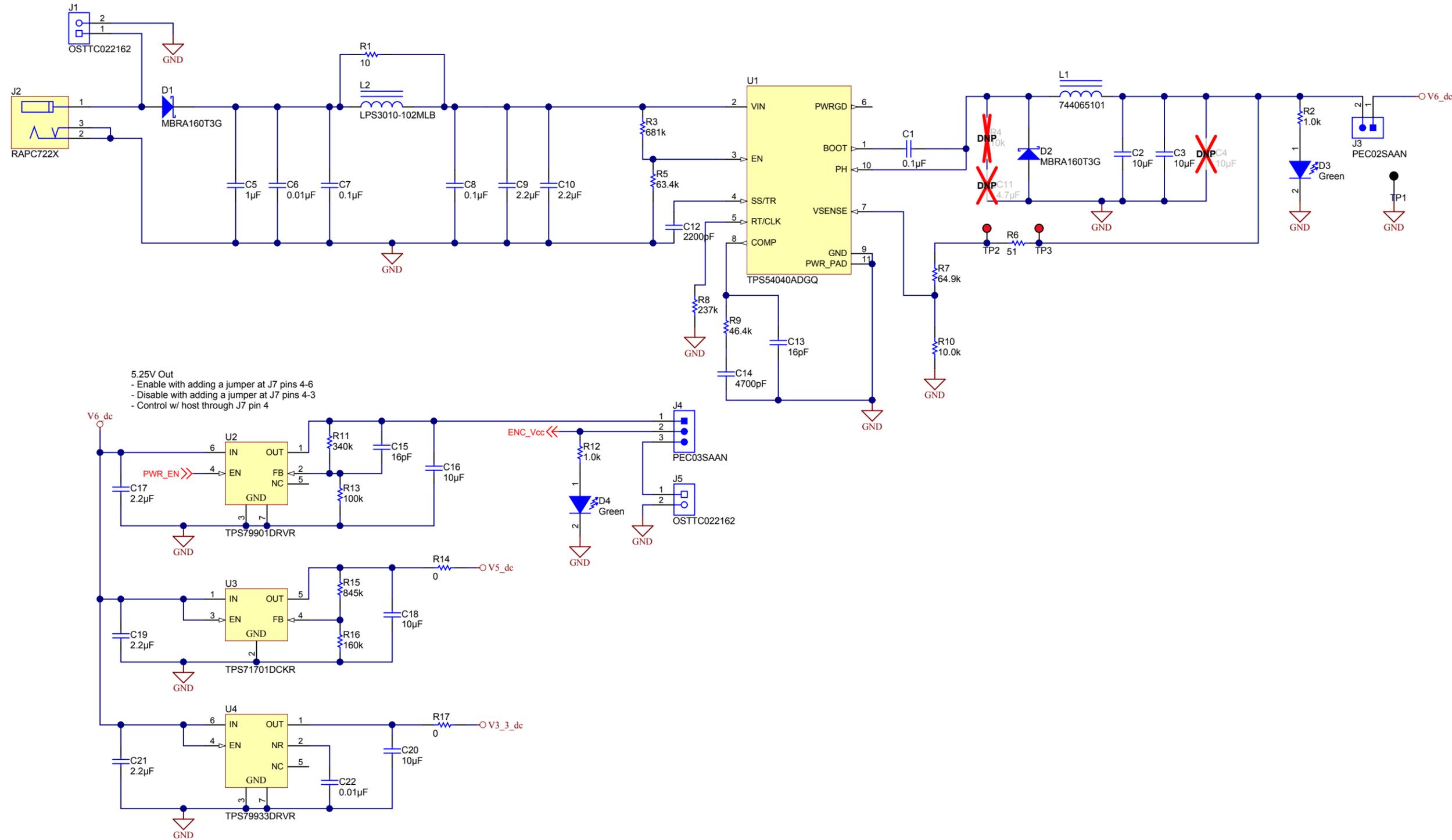




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SVN Rev: Version control disabled	Assembly Variant: TIDA-00176_REVE1_products	Sheet 2 of 3
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SVN Rev: Version control disabled	Assembly Variant: TIDA-00176_REVE1_products	Sheet: 2 of 3
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H1 NY PMS 440 0025 PH
 H2 NY PMS 440 0025 PH
 H3 NY PMS 440 0025 PH
 H4 NY PMS 440 0025 PH

H5 1902C
 H6 1902C
 H7 1902C
 H8 1902C

~~DNP~~ FID1
~~DNP~~ FID2
~~DNP~~ FID3

PCB Number: TIDA-00176
 PCB Rev: Rev E1

PCB
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Number: TIDA-00176	Rev: E1	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: TIDA-00176_REVE1_products	Sheet: 3 of 3
Drawn By:	File: TIDA-00176_BD.SchDoc	Size: B
Engineer: Stauder/Pizzolante/Staebler	Contact: http://www.ti.com/support	

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